

SERIES 24 AND 28 STANDARD AND LOW POWER PROGRAMMABLE READ-ONLY MEMORIES

SEPTEMBER 1979—REVISED AUGUST 1984

- Expanded Family of Standard and Low Power PROMs
- Titanium-Tungsten (Ti-W) Fuse Links for Reliable Low-Voltage Full-Family-Compatible Programming
- Full Decoding and Fast Chip Select Simplify System Design
- P-N-P Inputs for Reduced Loading On System Buffers/Drivers
- Each PROM Supplied With a High Logic Level Stored at Each Bit Location
- Applications Include:
 Microprogramming/Firmware Loaders
 Code Converters/Character Generators
 Translators/Emulators
 Address Mapping/Look-Up Tables

description

The 24 and 28 Series of monolithic TTL programmable read-only memories (PROMs) feature an expanded selection of standard and low-power PROMs. This expanded PROM family provides the system designer with considerable flexibility in upgrading existing designs or optimizing new designs. Featuring proven titanium-tungsten (Ti-W) fuse links with low-current MOS-compatible p-n-p inputs, all family members utilize a common programming technique designed to program each link with a 20-microsecond pulse.

The 4096-bit and 8192-bit PROMs are offered in a wide variety of packages ranging from 18-pin 300 mil-wide thru 24 pin 600 mil-wide. The 16,384-bit PROMs provide twice the bit density of the 8192-bit PROMs and are provided in a 24 pin 600 mil-wide package.

All PROMs are supplied with a logic-high output level stored at each bit location. The programming procedure will produce open-circuits in the Ti-W metal links, which reverses the stored logic level at the selected location. The procedure is irreversible; once altered, the output for that bit location is permanently programmed. Outputs that have never been altered may later be programmed to supply the opposite output level. Operation of the unit within the recommended operating conditions will not alter the memory content.

Active level(s) at the chip-select input(s) (S or \bar{S}) enables all of the outputs. An inactive level at any chip-select input causes all outputs to be in the three-state, or off condition.

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PROMS

standard PROMs

The standard PROM members of Series 24 and 28 offer high performance for applications which require the uncompromised speed of Schottky technology. The fast chip-select access times allow additional decoding delays to occur without degrading speed performance.

TYPE NUMBER	PACKAGE [†] AND TEMPERATURE RANGE DESIGNATORS	OUTPUT CONFIGURATION [‡]	BIT SIZE (ORGANIZATION)	TYPICAL PERFORMANCE		
				ADDRESS	SELECT	ACCESS TIMES
						POWER DISSIPATION
TBP24S10	MJ, J, N	▽	1024 Bits (256W × 4B)	35 ns	20 ns	375 mW
TBP24SA10	MJ, J, N	◇				
TBP28S42	MJ, J, N	▽				
TBP28SA42	MJ, J, N	◇				
TBP28S46	MJW, JW, NW	▽				
TBP28SA46	MJW, JW, NW	◇				
TBP24S41	MJ, J, N	▽	4096 Bits (1024 × 4B)	35 ns	20 ns	500 mW
TBP24SA41	MJ, J, N	◇				
TBP24S81	MJ, J, N	▽				
TBP24SA81	MJ, J, N	◇				
TBP28S86A	MJW, JW, NW	▽	8192 Bits (2048 × 4B)	40 ns	20 ns	625 mW
TBP28SA86A	MJW, JW, NW	◇				
TBP28S2708A	NW	▽				
TBP28S166	NW	▽	16,384 Bits (2048W × 8B)	45 ns	20 ns	650 mW
				35 ns	15 ns	

[†]MJ and MJW designates full-temperature-range circuits (formerly 54 Family), J, JW, N, and NW designates commercial-temperature-range circuits (formerly 74 Family).

[‡]▽ = three state, ◇ = open collector.

SERIES 24 AND 28 STANDARD AND LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES

low power PROMs

To upgrade systems utilizing MOS EPROMs or MOS PROMs, or when designing new systems which do not require maximum speed, the low-power PROM family offers the output drive and speed performance of bipolar technology, plus reduced power dissipation.

TYPE NUMBER	PACKAGE [†] AND TEMPERATURE RANGE DESIGNATORS	OUTPUT CONFIGURATION [‡]	BIT SIZE (ORGANIZATION)	TYPICAL PERFORMANCE		
				ACCESS TIMES		POWER DISSIPATION
				ADDRESS	SELECT	
TBP28L22	MJ, J,N	▽	2048 Bits (256W × 8B)	45 ns	20 ns	375 mW
TBP28LA22	MJ, J, N	◇	4096 Bits (512W × 8B)	60 ns	30 ns	250 mW
TBP28L42	MJ, J, N	▽	8192 Bits (1024W × 8B)	80 ns	35 ns	350 mW
TBP28L46	MJW, JW, NW	▽	16,384 Bits (2084W × 8B)	65 ns	30 ns	350 mW
TBP28L86A	MJW, JW, NW	▽				
TBP28L166	NW	▽				

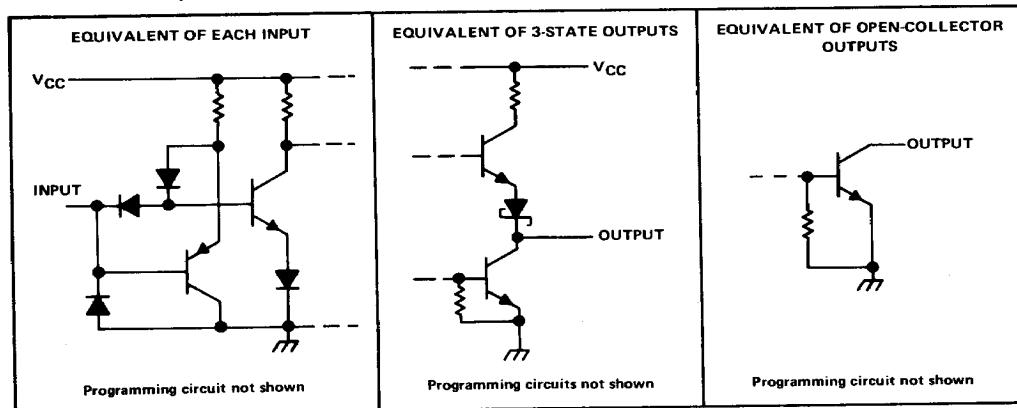
[†]MJ and MJW designates full-temperature-range circuits (formerly 54 Family). J, JW, N, and NW designates commercial-temperature-range circuits (formerly 74 Family).

[‡]▽ = three state, ◇ = open collector.

schematics of inputs and outputs

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PROMs



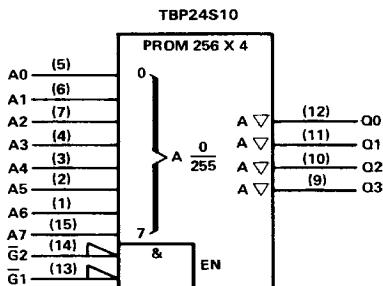
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage (see Note 1)	7 V
Input voltage	5.5 V
Chip-select peak input voltage (S, S1, S2) (see Note 2)	11 V
Off-state output voltage	5.5 V
Off-state peak output voltage (see Note 2)	16.25 V
Operating free-air temperature range: Full-temperature-range circuits (M suffix)	-55°C to 125°C
Commercial-temperature-range circuits	0°C to 70°C
Storage temperature range	-65°C to 150°C

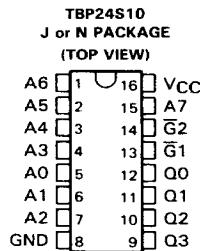
- NOTES: 1. Voltage values are with respect to network ground terminal.
2. These ratings apply only under the conditions described in the programming procedure.

TBP24S10
1024 BIT (256 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.8			0.8	V
I _{OH} High-level output current			-2			-6.5	mA
I _{OL} Low-level output current			16			16	mA
T _A Operating free-air temperature range	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _O = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-30	-100		-30	-100		mA
I _{CC}	V _{CC} = MAX		75	100		75	100	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF		35	75		35	55	ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		20	40		20	35	ns
t _{dis} Disable time	C _L = 5 pF See Note 3		15	40		15	35	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

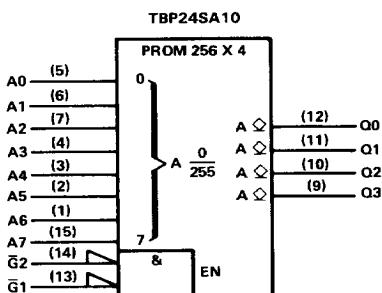
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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PROMs

TBP24SA10
1024 BITS (256 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment

TBP24SA10 J OR N PACKAGE (TOP VIEW)			
A6	1	16	VCC
A5	2	15	A7
A4	3	14	G2
A3	4	13	G1
A0	5	12	Q0
A1	6	11	Q1
A2	7	10	Q2
GND	8	9	Q3

recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage				0.8		0.8	V
V _{OH} High-level output voltage				5.5		5.5	V
I _{OL} Low-level output current				16		16	mA
T _A Operating free-air temperature range	-55	125	0	70			°C

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PROMs

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
I _{OH}	V _{CC} = MIN, V _{OH} = 2.4 V	0.05			0.05			mA
	V _{CC} = MIN, V _{OH} = 5.5 V			0.1			0.1	
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA	0.5			0.45			V
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V	25			25			μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V	-0.25			-0.25			mA
I _{CC}	V _{CC} = MAX	75	100		75	100		mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF	35	75		35	65		ns
t _{a(S)} Access time from chip select (enable time)	R _{L1} = 300 Ω	20	40		20	35		ns
t _{PLH} Propagation delay time low-to-high-level output from chip select	R _{L2} = 600 Ω See Note 3	15	40		20	35		ns

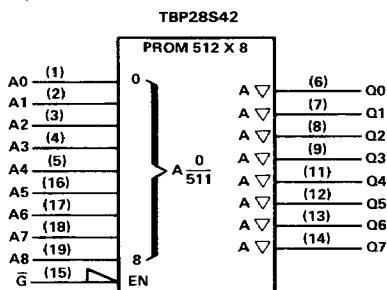
[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

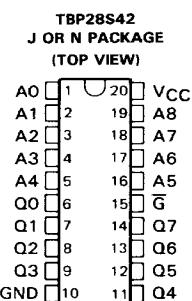
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage		2			2		V
V _{IL}	Low-level input voltage			0.8			0.8	V
I _{OH}	High-level output current			-2			-6.5	mA
I _{OL}	Low-level output current			16			16	mA
T _A	Operating free-air temperature range	-55		125	0		70	°C

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PROMs

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-30		-100	-30		-100	mA
I _{CC}	V _{CC} = MAX			100	135		100	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

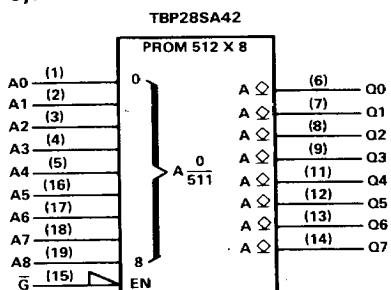
PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT	
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX		
t _{a(A)}	Access time from address	C _L = 30 pF		35	70		35	60	ns
t _{a(S)}	Access time from chip select (enable time)	See Note 3		20	45		20	45	ns
t _{dis}	Disable time	C _L = 5 pF		15	45		15	40	ns
		See Note 3							

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28SA42
4096 BITS (512 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment

TBP28SA42
J OR N PACKAGE
(TOP VIEW)

A0	1	20	VCC
A1	2	19	A8
A2	3	18	A7
A3	4	17	A6
A4	5	16	A5
Q0	6	15	G
Q1	7	14	Q7
Q2	8	13	Q6
Q3	9	12	Q5
GND	10	11	Q4

recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
V _{OH} High-level output voltage				5.5		5.5	V
I _{OL} Low-level output current				16		16	mA
T _A Operating free-air temperature range	-55		125	0		70	°C

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PROMS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT	
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX		
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V	
		V _{OH} = 2.4 V		0.05			0.05		
I _{OH}	V _{CC} = MIN, V _{OH} = 5.5 V			0.1			0.1	mA	
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V	
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA	
I _{IIH}	V _{CC} = MAX, V _I = 2.7 V			25			25	µA	
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA	
I _{ICC}	V _{CC} = MAX			105	135		105	135	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF	35	75		35	65		ns
t _{a(S)} Access time from chip select (enable time)	R _{L1} = 300 Ω	20	45		20	35		ns
t _{PLH} Propagation delay time low-to-high-level output from chip select	R _{L2} = 600 Ω See Note 3	15	45		15	35		ns

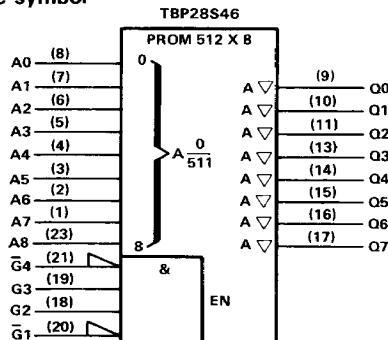
[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28S46
4096 BITS (512 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment

TBP28S46 JW OR NW PACKAGE (TOP VIEW)		
A7	1	24
A6	2	23
A5	3	22
A4	4	21
A3	5	20
A2	6	19
A1	7	18
A0	8	17
Q0	9	16
Q1	10	15
Q2	11	14
GND	12	13
		Q3

recommended operating conditions

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage		2			2		V
V _{IL}	Low-level input voltage				0.8		0.8	V
I _{OH}	High-level output current				-2		-6.5	mA
I _{OL}	Low-level output current				16		16	mA
T _A	Operating free-air temperature range	-55	125	0	0	70	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-15	-100		-20	-100		mA
I _{CC}	V _{CC} = MAX		100	135		100	135	mA

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PROMs

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)}	Access time from address	C _L = 30 pF	35	70	35	60		ns
t _{a(S)}	Access time from chip select (enable time)	See Note 3	20	45	20	35		ns
t _{dis}	Disable time	C _L = 5 pF See Note 3	15	40	15	35		ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

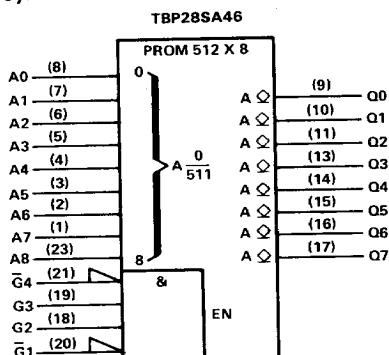
[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28SA46
4096 BITS (512 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment

TBP28SA46 JW OR NW PACKAGE (TOP VIEW)		
A7	1	24 VCC
A6	2	23 A8
A5	3	22 NC
A4	4	21 G4
A3	5	20 G1
A2	6	19 G3
A1	7	18 G2
A0	8	17 Q7
Q0	9	16 Q6
Q1	10	15 Q5
Q2	11	14 Q4
GND	12	13 Q3

recommended operating conditions

PARAMETER	MJW			JW OR NW			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage				0.8			V
V _{OH} High-level output voltage				5.5			V
I _{OL} Low-level output current				16			mA
T _A Operating free-air temperature range	-55	125	0	0	70	70	°C

4

PROMs

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
		V _{OH} = 2.4 V		0.05			0.05	
I _{OH}	V _{CC} = MIN, V _{OH} = 5.5 V			0.1			0.1	mA
	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			1			1	mA
I _I	V _{CC} = MAX, V _I = 5.5 V			25			25	μA
I _{II}	V _{CC} = MAX, V _I = 2.7 V			-0.25			-0.25	mA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			100	135		100	135
I _{CC}	V _{CC} = MAX							mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJW		JW OR NW		UNIT	
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX
t _{a(A)} Access time from address	C _L = 30 pF	35	75		35	65	ns
t _{a(S)} Access time from chip select (enable time)	R _{L1} = 300 Ω	20	45		20	35	ns
t _{PLH} Propagation delay low-to-high-level output from chip select	R _{L2} = 600 Ω See Note 3	15	40		15	35	ns

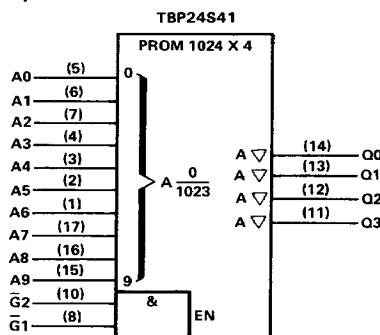
[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP24S41
4096 BITS (1024 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment

TBP24S41 J OR N PACKAGE (TOP VIEW)					
A6	1	18	VCC		
A5	2	17	A7		
A4	3	16	A8		
A3	4	15	A9		
A0	5	14	Q0		
A1	6	13	Q1		
A2	7	12	Q2		
̄G1	8	11	Q3		
GND	9	10	̄G2		

recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
I _{OH} High-level output current				-2		-3.2	mA
I _{OL} Low-level output current				16		16	mA
T _A Operating free-air temperature range	-55	125	0	70			°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS[§]}	V _{CC} = MAX	-15	-100	-20	-20	-100	-100	mA
I _{CC}	V _{CC} = MAX		95	140		95	140	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF		40	75		40	60	ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		20	40		20	30	ns
t _{dis} Disable time	C _L = 5 pF See Note 3		20	40		20	'30	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

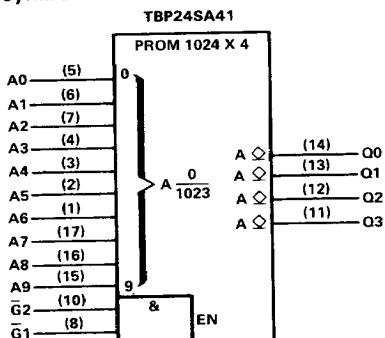
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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PROMS

TBP24SA41
4096 BITS (1024 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment

TBP24SA41 J OR N PACKAGE (TOP VIEW)					
A6	1	18	VCC		
A5	2	17	A7		
A4	3	16	A8		
A3	4	15	A9		
A0	5	14	Q0		
A1	6	13	Q1		
A2	7	12	Q2		
G1	8	11	Q3		
GND	9	10	G2		

recommended operating conditions

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage		2		2			V
V _{IL}	Low-level input voltage				0.8		0.8	V
V _{OH}	High-level output voltage				5.5		5.5	V
I _{OL}	Low-level output current				16		16	mA
T _A	Operating free-air temperature range	-55		125	0		70	°C

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PROMs

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I ₁ = -18 mA			-1.2			-1.2	V
		V _{OH} = 2.4 V		0.05			0.05	
I _{OH}	V _{CC} = MIN, V _{OH} = 5.5 V			0.1			0.1	mA
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I ₁	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{CC}	V _{CC} = MAX			95	140		95	140

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)}	Access time from address			40	75		40	60
	C _L = 30 pF							ns
t _{a(S)}	Access time from chip select (enable time)			20	40		20	30
	R _{L1} = 300 Ω							ns
t _{PLH}	Propagation delay time low-to-high-level output from chip select			20	40		20	30
	R _{L2} = 600 Ω							ns
	See Note 3							

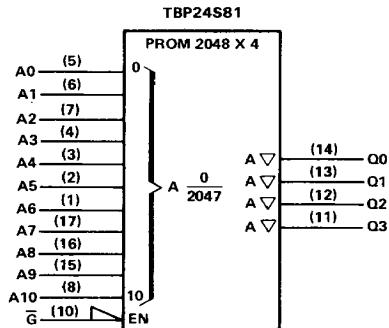
[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

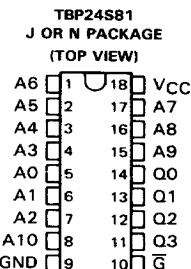
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP24S81
8192 BITS (2048 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
I _{OH} High-level output current				-2		-3.2	mA
I _{OL} Low-level output current				16		16	mA
T _A Operating free-air temperature range	-55	125	0	0	70	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-15	-100	-20	-20	-100	-100	mA
I _{CC}	V _{CC} = MAX		125	175		125	175	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF		45	85		45	70	ns
	See Note 3		20	50		20	40	ns
t _{dis} Disable time	C _L = 5 pF		20	50		20	40	ns
	See Note 3							

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

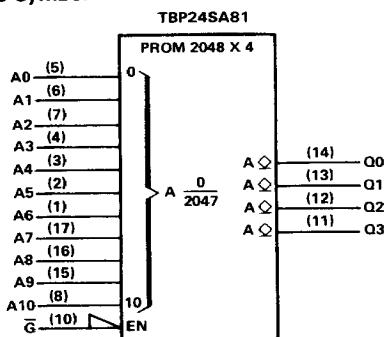
[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4 PROMS

TBP24SA81
8192 BITS (2048 WORDS BY 4 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment

TBP24SA81 J OR N PACKAGE (TOP VIEW)					
A6	1	18	VCC		
A5	2	17	A7		
A4	3	16	A8		
A3	4	15	A9		
A0	5	14	Q0		
A1	6	13	Q1		
A2	7	12	Q2		
A10	8	11	Q3		
GND	9	10	G		

recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
V _{OH} High-level output voltage				5.5		5.5	V
I _{OL} Low-level output current				16		16	mA
T _A Operating free-air temperature range	-55	125	0	70			°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PROMS

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
I _{OH}	V _{CC} = MIN, V _{OH} = 2.4 V			0.05			0.05	VmA
	V _{OH} = 5.5 V			0.1			0.1	
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{CC}	V _{CC} = MAX			125	175		125	175

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

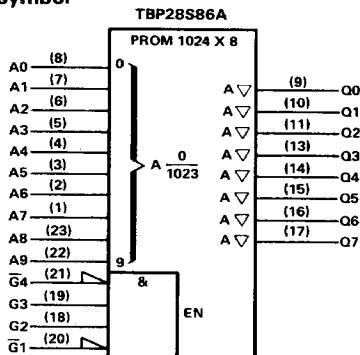
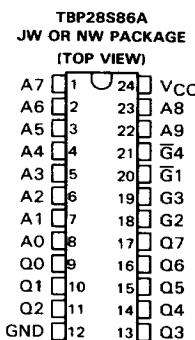
PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF		45	95		45	70	ns
t _{a(S)} Access time from chip select (enable time)	R _{L1} = 300 Ω		20	50		20	40	ns
t _{PLH} Propagation delay time low-to-high-level output from chip select	R _{L2} = 600 Ω See Note 3		20	50		20	40	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

**8192 BITS (1024 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS**

logic symbol**pin assignment****recommended operating conditions**

PARAMETER	MJW			JW OR NW			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage				0.8			V
I _{OH} High-level output current				-2			mA
I _{OL} Low-level output current				12			mA
T _A Operating free-air temperature range	-55	125	0	70			°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT		
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX			
V _{IK}	V _{CC} = MIN, I _l = -18 mA				-1.2			-1.2	V	
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1			V	
V _{OL}	V _{CC} = MIN, I _{OL} = 12 mA				0.5			0.5	V	
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V				50			50	μA	
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V				-50			-50	μA	
I _I	V _{CC} = MAX, V _I = 5.5 V				1			1	mA	
I _{IH}	V _{CC} = MAX, V _I = 2.7 V				25			25	μA	
I _{IL}	V _{CC} = MAX, V _I = 0.5 V				-0.25			-0.25	mA	
I _{OS} [§]	V _{CC} = MAX	-15		-100	-20		-100		mA	
I _{CC}	V _{CC} = MAX				110	170		110	165	mA

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PROMS

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

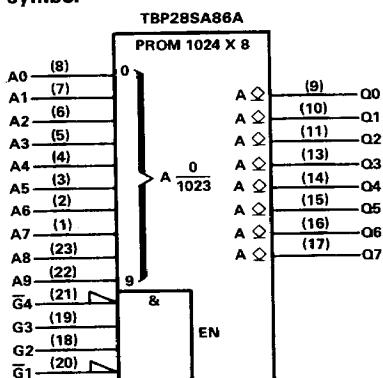
PARAMETER	TEST CONDITIONS	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{aA}) Access time from address	C _L = 30 pF		35	80	35	65		ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		20	50	20	40		ns
t _{dis} Disable time	C _L = 5 pF See Note 3		15	40	15	35		ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

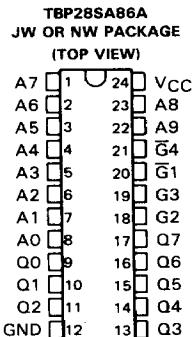
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28SA86A
8192 BITS (1024 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	TEST CONDITIONS	MJW			JW OR NW			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage				0.8			V
V _{OH}	High-level output voltage				5.5			V
I _{OL}	Low-level output current				12			mA
T _A	Operating free-air temperature range	-55	125	0	70			°C

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PROMS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT	
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX		
V _{IK}	V _{CC} = MIN, I _l = -18 mA				-1.2			-1.2	V
I _{OH}	V _{CC} = MIN, V _{OH} = 2.4 V				0.05			0.05	mA
	V _{OH} = 5.5 V				0.1			0.1	
V _{OL}	V _{CC} = MIN, I _{OL} = 12 mA				0.5			0.5	V
I _l	V _{CC} = MAX, V _I = 5.5 V				1			1	mA
I _{lH}	V _{CC} = MAX, V _I = 2.7 V				25			25	μA
I _{lL}	V _{CC} = MAX, V _I = 0.5 V				-0.25			-0.25	mA
I _{CC}	V _{CC} = MAX	125	175		125	175		125	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

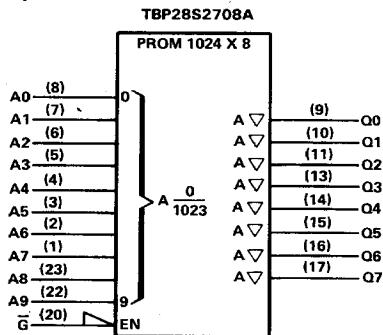
PARAMETER	TEST CONDITIONS	MJW			JW OR NW			UNIT	
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX		
t _{a(A)}	Access time from address				35	80	35	70	ns
t _{a(S)}	Access time from chip select (enable time)	C _L = 30 pF			20	50	20	40	ns
t _{PLH}	Propagation delay time low-to-high-level output from chip select	R _{L1} = 300 Ω			R _{L2} = 600 Ω		15	40	ns
		See Note 3					15	35	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

logic symbol



pin assignment

TBP28S2708A NW PACKAGE (TOP VIEW)		
A7	1	24 V _{CC}
A6	2	23 A ₈
A5	3	22 A ₉
A4	4	21 NC
A3	5	20 G
A2	6	19 NC
A1	7	18 NC
A0	8	17 Q ₇
Q0	9	16 Q ₆
Q1	10	15 Q ₅
Q2	11	14 Q ₄
GND	12	13 Q ₃

recommended operating conditions

PARAMETER	NW			UNIT
	MIN	NOM	MAX	
V _{CC} Supply voltage	4.75	5	5.25	V
V _{IH} High-level input voltage		2		V
V _{IL} Low-level input voltage			0.8	V
I _{OH} High-level output current			-3.2	mA
I _{OL} Low-level output current			12	mA
T _A Operating free-air temperature range	0	70		°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	NW			UNIT
		MIN	TYP [†]	MAX	
V _{IK}	V _{CC} = 4.75, I _I = -18 mA			-1.2	V
V _{OH}	V _{CC} = 4.75, I _{OH} = -3.2 mA	2.4	3.1		V
V _{OL}	V _{CC} = 4.75, I _{OL} = 12 mA			0.5	V
I _{OZH}	V _{CC} = 5.25, V _O = 2.4 V			50	μA
I _{OZL}	V _{CC} = 5.25, V _O = 0.5 V			-50	μA
I _I	V _{CC} = 5.25, V _I = 5.5 V			1	mA
I _{IH}	V _{CC} = 5.25, V _I = 2.7 V			25	μA
I _{IL}	V _{CC} = 5.25, V _I = 0.5 V			-0.25	mA
I _{OS} [‡]	V _{CC} = 5.25	-20		-100	mA
I _{CC}	V _{CC} = 5.25			110 165	mA

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PROMS

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

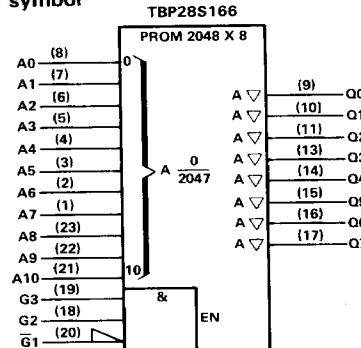
PARAMETER	TEST CONDITIONS	NW			UNIT
		MIN	TYP [†]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF		45	70	ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		20	40	ns
t _{dis} Disable time	C _L = 5 pF See Note 3		20	40	ns

[†]All typical values are at V_{CC} = 5 V, T_A = 25 °C.[‡]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28S166
16,384 BITS (2084 WORDS BY 8 BITS)
STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment

TBP28S166 NW PACKAGE (TOP VIEW)			
A7	1	24	V _{CC}
A6	2	23	A8
A5	3	22	A9
A4	4	21	A10
A3	5	20	G
A2	6	19	G3
A1	7	18	G2
A0	8	17	Q7
Q0	9	16	Q6
Q1	10	15	Q5
Q2	11	14	Q4
GND	12	13	Q3

recommended operating conditions

PARAMETER	NW			UNIT	
	MIN	NOM	MAX		
V _{CC}	Supply voltage	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
I _{OH}	High-level output current			-3.2	mA
I _{OL}	Low-level output current			16	mA
T _A	Operating free-air temperature range	0	70		°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PROMs

PARAMETER	TEST CONDITIONS	NW			UNIT	
		MIN	TYP [†]	MAX		
V _{IK}	V _{CC} = 4.75, I _I = -18 mA			-1.2	V	
V _{OH}	V _{CC} = 4.75, I _{OH} = -3.2 mA	2.4	3.1		V	
V _{OL}	V _{CC} = 4.75, I _{OL} = 16 mA			0.5	V	
I _{OZH}	V _{CC} = 5.25, V _O = 2.4 V			50	μA	
I _{OZL}	V _{CC} = 5.25, V _O = 0.5 V			-50	μA	
I _I	V _{CC} = 5.25, V _I = 5.5 V			1	mA	
I _{IH}	V _{CC} = 5.25, V _I = 2.7 V			25	μA	
I _{IL}	V _{CC} = 5.25, V _I = 0.5 V			-0.25	mA	
I _{OS[‡]}	V _{CC} = 5.25			-20	-100	mA
I _{CC}	V _{CC} = 5.25			130	175	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	NW			UNIT	
		MIN	TYP [†]	MAX		
t _{a(A)}	Access time from address	C _L = 30 pF		35	75	ns
t _{a(S)}	Access time from chip select (enable time)	See Note 3		15	40	ns
t _{dis}	Disable time	C _L = 5 pF		15	40	ns
		See Note 3				

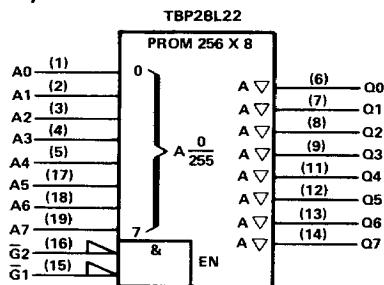
[†]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[‡]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

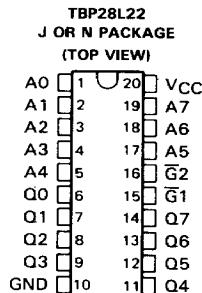
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28L22
2048 BITS (256 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
I _{OH} High-level output current				-2		-6.5	mA
I _{OL} Low-level output current				16		16	mA
T _A Operating free-air temperature range	-55	125	0	70			°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-25	-100		-30	-100		mA
I _{CC}	V _{CC} = MAX			75	100		75	100

4

PROMS

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{aA} Access time from address	C _L = 30 pF		45	75		45	70	ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		20	40		20	35	ns
t _{dis} Disable time	C _L = 5 pF See Note 3		15	35		15	30	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

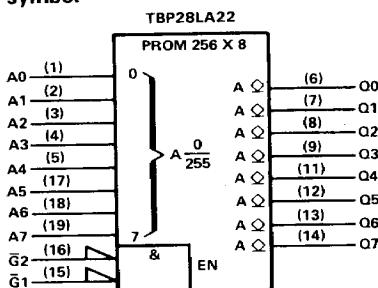
[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

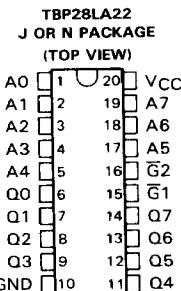
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28LA22
2048 BITS (256 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.8			0.8	V
V _{OH} High-level output voltage			5.5			5.5	V
I _{OL} Low-level output current			16			16	mA
T _A Operating free-air temperature range	-55		125	0		70	°C

4

PROMs

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA			-1.2			-1.2	V
I _{OH}	V _{CC} = MIN, V _{OH} = 2.4 V V _{OH} = 5.5 V			0.05			0.05	mA
V _{OL}	V _{CC} = MIN, I _{OL} = 16 mA			0.5			0.5	V
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{CC}	V _{CC} = MAX	75	100		75	100		mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT	
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX		
t _{aA}	Access time from address			40	80		45	75	ns
t _{aS}	Access time from chip select (enable time)			20	40		20	35	ns
t _{PLH}	Propagation delay time low-to-high-level output from chip select			RL ₁ = 300 Ω RL ₂ = 600 Ω See Note 3	15	35	15	30	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

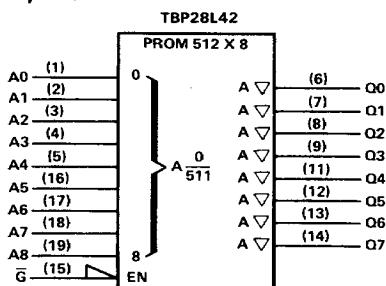
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TBP28L42

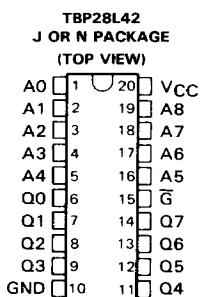
4096 BITS (512 WORDS BY 8 BITS)

LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment



recommended operating conditions

PARAMETER	MJ			J OR N			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
I _{OH} High-level output current				-1		-1.6	mA
I _{OL} Low-level output current				8		8	mA
T _A Operating free-air temperature range	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA				-1.2		-1.2	V
V _{QH}	V _{CC} = MIN, I _{QH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 8 mA			0.5		0.5		V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50		50		μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50		-50		μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1		1		mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25		25		μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25		-0.25		mA
I _{OS} [§]	V _{CC} = MAX	-10		-100	-10		-100	mA
I _{CC}	V _{CC} = MAX		50	85		50	85	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJ			J OR N			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF		55	110		55	95	ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		25	60		25	60	ns
t _{dis} Disable time	C _L = 5 pF See Note 3		25	50		25	40	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

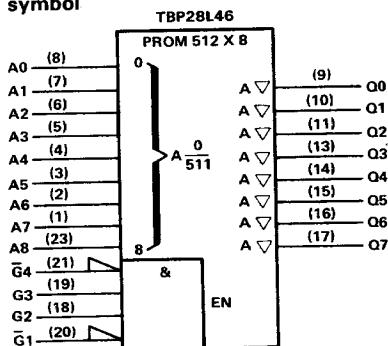
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

4

PROMs

TBP28L46
4096 BITS (512 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment

TBP28L46 JW OR NW PACKAGE (TOP VIEW)					
A7	1	24	VCC		
A6	2	23	A8		
A5	3	22	NC		
A4	4	21	G4		
A3	5	20	G1		
A2	6	19	G3		
A1	7	18	G2		
A0	8	17	Q7		
Q0	9	16	Q6		
Q1	10	15	Q5		
Q2	11	14	Q4		
GND	12	13	Q3		

recommended operating conditions

PARAMETER	MJW			JW OR NW			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage				0.8			V
I _{OH} High-level output current				-1			mA
I _{OL} Low-level output current				8			mA
T _A Operating free-air temperature range	-55		125	0		70	°C

4

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PROMs

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _I = -18 mA				-1.2			-1.2 V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 8 mA			0.5			0.5	μA
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IIH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IIL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-10		-100	-10		-100	mA
I _{CC}	V _{CC} = MAX			50	85		50	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
t _{a(A)} Access time from address	C _L = 30 pF	55	110		55	95		ns
t _{a(S)} Access time from chip select (enable time)	See Note 3	25	60		25	60		ns
t _{dis} Disable time	C _L = 5 pF See Note 3	25	50		25	40		ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

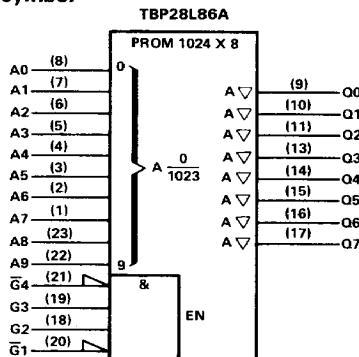
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 225012 • DALLAS, TEXAS 75265

TBP28L86A
8192 BITS (1024 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment

TBP28L86A JW OR NW PACKAGE (TOP VIEW)					
A7	1	24	VCC		
A6	2	23	A8		
A5	3	22	A9		
A4	4	21	G4		
A3	5	20	G1		
A2	6	19	G3		
A1	7	18	G2		
A0	8	17	Q7		
Q0	9	16	Q6		
Q1	10	15	Q5		
Q2	11	14	Q4		
GND	12	13	Q3		

recommended operating conditions

PARAMETER	MJW			JW OR NW			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage		2			2		V
V _{IL} Low-level input voltage				0.8		0.8	V
I _{OH} High-level output current				-1		-1.6	mA
I _{OL} Low-level output current				8		8	mA
T _A Operating free-air temperature range	-55	125	0	0	70	70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]	MJW			JW OR NW			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V _{IK}	V _{CC} = MIN, I _l = -18 mA			-1.2			-1.2	V
V _{OH}	V _{CC} = MIN, I _{OH} = MAX	2.4	3.1		2.4	3.1		V
V _{OL}	V _{CC} = MIN, I _{OL} = 8 mA			0.5			0.5	V
I _{OZH}	V _{CC} = MAX, V _O = 2.4 V			50			50	μA
I _{OZL}	V _{CC} = MAX, V _O = 0.5 V			-50			-50	μA
I _I	V _{CC} = MAX, V _I = 5.5 V			1			1	mA
I _{IH}	V _{CC} = MAX, V _I = 2.7 V			25			25	μA
I _{IL}	V _{CC} = MAX, V _I = 0.5 V			-0.25			-0.25	mA
I _{OS} [§]	V _{CC} = MAX	-10	-100	-10	-10	-100	-100	mA
I _{CC}	V _{CC} = MAX		55	95		55	80	mA

4

PROMs

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MJW		JW OR NW		UNIT	
		MIN	TYP [‡]	MAX	MIN		
t _{a(A)} Access time from address	C _L = 30 pF		65	200	65	110	ns
t _{a(S)} Access time from chip select (enable time)	See Note 3		40	125	40	80	ns
t _{dis} Disable time	C _L = 5 pF See Note 3		25	100	25	60	ns

[†]For conditions shown as MIN or MAX, use appropriate value specified under recommended operating conditions.

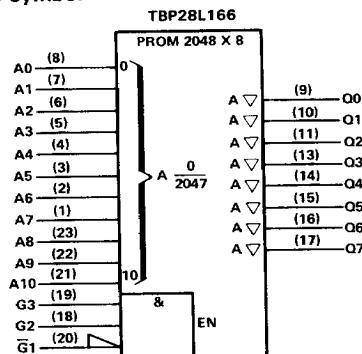
[‡]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[§]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TRP28L166
16,384 BITS (2084 WORDS BY 8 BITS)
LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

logic symbol



pin assignment

TBP28L166 NW PACKAGE (TOP VIEW)		
A7	1	24 V _{CC}
A6	2	23 A ₈
A5	3	22 A ₉
A4	4	21 A ₁₀
A3	5	20 G
A2	6	19 G ₃
A1	7	18 G ₂
A0	8	17 Q ₇
Q0	9	16 Q ₆
Q1	10	15 Q ₅
Q2	11	14 Q ₄
GND	12	13 Q ₃

recommended operating conditions

PARAMETER	NW			UNIT
	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.75	5	5.25 V
V _{IH}	High-level input voltage		2	V
V _{IL}	Low-level input voltage		0.8	V
I _{OH}	High-level output current		-1.6	mA
I _{OL}	Low-level output current		8	mA
T _A	Operating free-air temperature range	0	70	°C

4

PROMs

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	NW			UNIT
		MIN	TYPT [†]	MAX	
V _{IK}	V _{CC} = 4.75, I _I = -18 mA			-1.2	V
V _{OH}	V _{CC} = 4.75, I _{OH} = -1.6 mA	2.4	3.1		V
V _{OL}	V _{CC} = 4.75, I _{OL} = 8 mA			0.5	V
I _{OZH}	V _{CC} = 5.25, V _O = 2.4 V			50	μA
I _{OZL}	V _{CC} = 5.25, V _O = 0.5 V			-50	μA
I _I	V _{CC} = 5.25, V _I = 5.5 V			1	mA
I _{IH}	V _{CC} = 5.25, V _I = 2.7 V			25	μA
I _{IL}	V _{CC} = 5.25, V _I = 0.5 V			-0.25	mA
I _{OS[‡]}	V _{CC} = 5.25	-10	-100		mA
I _{CC}	V _{CC} = 5.25			75 110	mA

switching characteristics over recommended ranges of T_A and V_{CC} (unless otherwise noted)

PARAMETER	TEST CONDITIONS	NW			UNIT
		MIN	TYPT [†]	MAX	
t _{a(A)}	Access time from address	C _L = 30 pF	80	125	ns
t _{a(S)}	Access time from chip select (enable time)	See Note 3	40	65	ns
t _{dis}	Disable time	C _L = 5 pF	30	65	ns
		See Note 3			

[†]All typical values are at V_{CC} = 5 V, T_A = 25 °C.

[‡]Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

**SERIES 24 AND 28
PROGRAMMABLE READ-ONLY MEMORIES**

recommended operating conditions for programming (see Figure 1)

		MIN	NOM	MAX	UNIT
Steady-state supply voltage	V _{CC}	4.75	5	5.25	V
Input voltage	V _{IH}	3	4	5	V
	V _{IL}	0	0	0.5	
Voltage at all outputs except the one to be programmed		0	0	0.5	V
Supply voltage level to program a bit	V _{CC(pr)}	5.75	6	6.25	V
Select or enable level to program a bit	V _{S(pr)}	9.75	10	11	V
Output level during interval t ₅	V _{O(pr)}	15.75	16	16.25	V
Supply voltage during verification (see step 14)	Low	4.4	4.5	4.6	V
	High	5.4	5.5	5.6	
Time from V _{CC} to settle and to verify need to program	t ₁	0	5	10	μs
Time from V _{CC} = 6 V until chip select (enable) is at 10 V	t ₂	5	5	10	μs
Time from chip select (enable) high to start of program ramp	t ₃	0.1	5	10	μs
Ramp time, output program pulse	t ₄	10	15	20	μs
Duration of output program pulse	t ₅	15	20	20	μs
Time from end of program pulse to chip select (enable) low	t ₆	5	5	10	μs
Time from chip select (enable) V _{CC} = 0 V	t ₇	0.1	5	5	μs
Time for cooling between bits	t ₈	30	50	100	μs
Time for cooling between words	t ₉	30	50		μs
Free-air temperature	T _A	20	25	30	°C

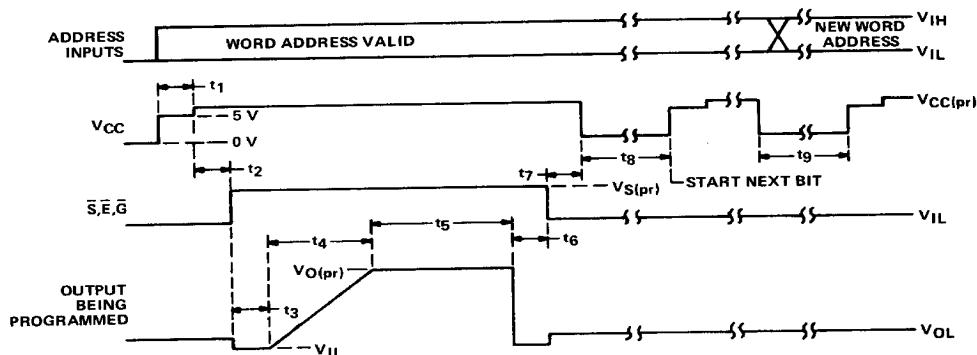
step-by-step programming instruction (see Figure 1)

1. Address the word to be programmed, apply 5 volts to V_{CC} and active levels to all chip select (S and \bar{S}) or chip enable (E and \bar{E}) inputs.
2. Verify the status of a bit location by checking the output level.
3. Decrease V_{CC} to 0 volts.
4. For bit locations that do not require programming, skip steps 5 through 11.
5. Increase V_{CC} to V_{CC(pr)} with a minimum current capability of 250 milliamperes.
6. Apply V_{S(pr)} to all the \bar{S} , \bar{E} or \bar{G} inputs. I_f ≤ 25 milliamperes. Active-high enables may be left high.
7. Connect all outputs, except the one to be programmed, to V_{IL}. Only one bit is to be programmed at a time.
8. Apply the output programming pulse for 20 microseconds. Minimum current capability of the programming supply should be 250 milliamperes.
9. After terminating the output pulse, disconnect all outputs from V_{IL} conditions.
10. Reduce the voltage at \bar{S} , \bar{E} , or \bar{G} inputs to V_{II}.
11. Decrease V_{CC} to 0 volts.
12. Return to step 4 until all outputs in the word have been programmed.
13. Repeat steps 2 through 11 for each word in memory.
14. Verify programming of every word after all words have been programmed using V_{CC} values of 4.5 and 5.5 volts.

4

PROMs

SERIES 24 AND 28 PROGRAMMABLE READ-ONLY MEMORIES



NOTE 4: Rise and fall times should be $\leq 1 \mu\text{s}$.

FIGURE 1. TIMING DIAGRAM AND VOLTAGE WAVEFORMS FOR PROGRAMMING SEQUENCE

4

PROMs